

Product / Process Change Notification (PCN)

Notification Date: July 2, 2024

PCN Number: PCN-2402

PCN Title: Fluxless Die Attach Implementation

Product/ Process Identification: All discrete products, whether standard or custom. This includes the following base parts:

- FBG04N08A
- FBG10N05A
- FBG20N04A
- FBG30N04C
- EPC7002A
- EPC7019G
- EPC7014UB
- EPC7003A
- EPC7018G
- EPC7020G
- EPC7030G

Description of Change: Flux solder paste will no longer be used in the FSMD-A, FSMD-C, FSMD-G, and UB package type products during manufacturing to boost reliability and enhance yield. This change will not impact the form, fit, or function of the products. The updated process has passed EPCS's qualification successfully. This change will be effective on product listed above beginning with LDC 2427.

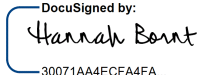
Information Requests

If there are any questions, comments or information required regarding this PCN please contact your local EPCS Sales Representative.

EPCS considers this change approved if we do not receive any written objection within 30 days from notification date of this PCN letter. If EPCS receives objection, then EPCS will provide a 90-day transition period from the date of PCN notification.

EPCS Approval

This PCN has been reviewed by EPCS's Quality & Reliability Department:

Signature: 30071AA4ECFA4FA...

Name: Hannah Bornt

Date: 7/2/2024